

HSF

NOTES:

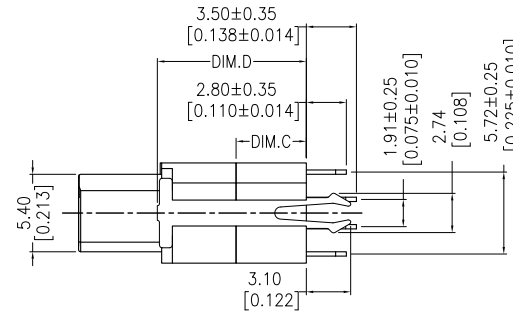
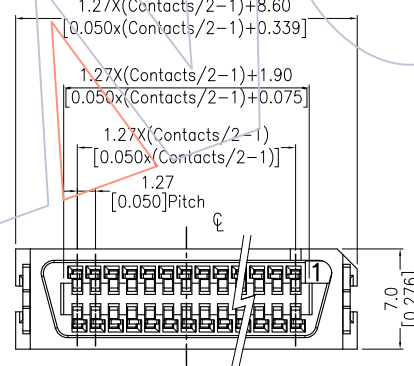
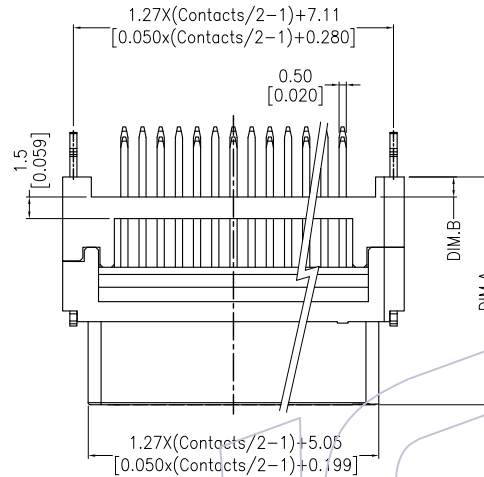
Current Rating:0.5A/Contact
Voltage Rating:250V AC
Contact Resistance:35milliohm Max
Withstand Voltage:500V AC/DC
Insulation Resistance:500Megohm Min
Operation Temperature:-20°C to +105°C

Housing Material:PBT+30%GF(UL94V-0)
Cover Material:PBT+30%GF(UL94V-0)
Terminal Material:Phosphor Bronze
Holding pin Material:Phosphor Bronze
Terminal plating:Sn-Au over Ni Plating
Holding pin plating:Sn over Ni Plating

Ordering Information

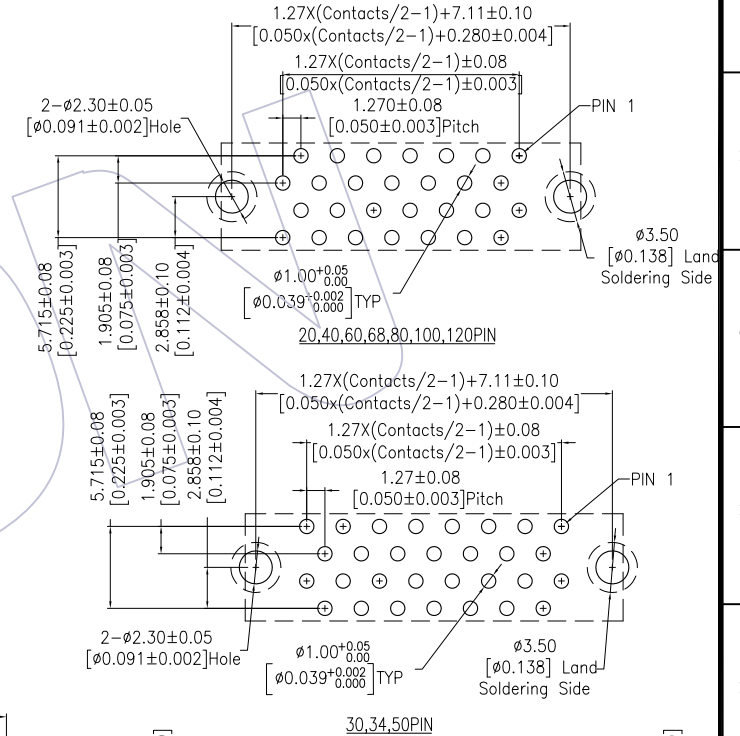
6325D-XXX SD XX P X X 0 X

No.of Pins	Contact Plating	Type	Packing
20 60	S1=3u"Gold/Tin	W:With Board Lock	T=Tube
30 68	S2=5u"Gold/Tin	N:Without Board Lock	
34 80	S3=10u"Gold/Tin		
40 100	S4=15u"Gold/Tin		
50 120	S5=30u"Gold/Tin		

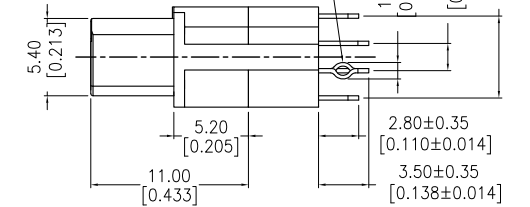


With Board Lock

Recommended P.C.B Layout (Top Side) (PCB BOARD TOLERANCE±0.05)



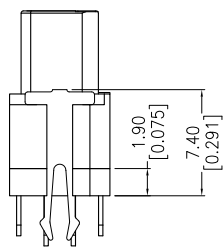
Kinked Contact
(Each 2 contact at both ends)



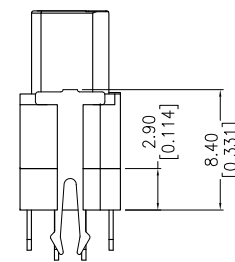
Without Board Lock

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	Fit	PART NO.
				X.X ±0.40	Ts insn	2013/02/07	UNIT	mm	6325D-XXXSDXXPXX0X
				X.XX ±0.25	CHECK	DATE	SIZE	inch	TITLE:
				X.XXX ±0.15	APPROVE	DATE	SHEET	A4	1.27mm SCSI D-Type
				Angle ± 3'			PROJ.	1/2	Female 180° DIP Add Cover
				DIM TOL					Customer NO.

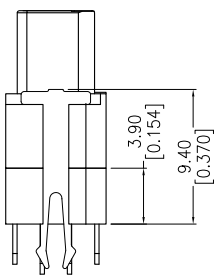
HSF



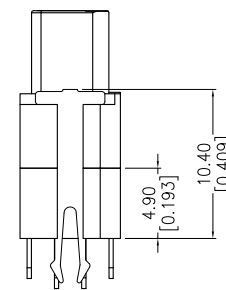
6325D-XXXSDXXPXX01



6325D-XXXSDXXPXX02



6325D-XXXSDXXPXX03



6325D-XXXSDXXPXX04

PART NO.	DIM.A	DIM.B	DIM.C	DIM.D
6325D-XXXSDXXPXX01	12.90	0.40	1.90	7.40
6325D-XXXSDXXPXX02	13.90	0.40	2.90	8.40
6325D-XXXSDXXPXX03	14.90	0.40	3.90	9.40
6325D-XXXSDXXPXX04	15.90	1.40	4.90	10.40

				OPERATION		DRAW Tsinsn	DATE	SCALE	Fit	PART NO. 6325D-XXXSDXXPXX0X	
				X.X	±0.40		2013/02/07	UNIT	$\frac{\text{mm}}{\text{inch}}$		
				X.XX	±0.25	CHECK	DATE	SIZE	A4	1.27mm SCSI D-Type Female 180° DIP Add Cover	
A0	2013/02/07	NEW	-----	X.XXX	±0.15			SHEET	2/2		
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL	APPROVE	DATE	PROJ.		Customer NO.	